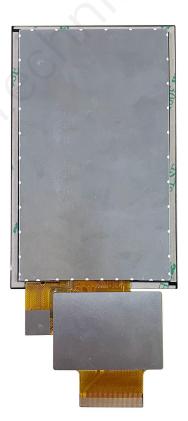
DMG80480F043_01WTCJM

Features:

- Powered by T5L0 ASIC, running DGUS II HMI platform.
- 4.3 inch, 480*800 resolution, IPS-TFT LCD.
- Optical bonding CTP, semi-transparent mirror cover plate, beautiful product and reliable structure.
- COF structure. The entire core circuit of the smart screen is fixed on the FPC of LCM, featured by light and thin structure, low cost and easy production.





1 External Interface



	k				
PIN	Definition	I/O	Functional Description		
1	+5V	I	Dower cumply DC2 6 F 5V		
2	+5V	ı	Power supply, DC3.6-5.5V.		
3	GND	GND			
4	GND	GND	GND		
5	GND	GND			
6	AD7	I	5 input ADCs. 12-bit resolution in case of 3.3V power supply. 0-3.3V		
7	AD6		input voltage. Except for AD6, the rest data is sent to OS core via UART3 in real time with 16KHz sampling rate. AD1 and AD5 can be		
8	AD5		used in parallel, and AD3 and AD7 can be used in parallel, which equals to two 32KHz sampling AD. AD1, AD3, AD5, AD7 can be used in		
9	AD3	ı	parallel, which equals to a 64KHz sampling AD; the data is summed		
10	AD1	ı	1024 times and then divided by 64 to obtain a 64Hz 16bit AD value by oversampling.		
11	+3.3	0	3.3V output, maximum load of 150mA.		
12	SPK	0	External MOSFET to drive buzzer or speaker. The external 10K resistor should be pulled down to the ground to ensure that power-on is low level.		
13	SD_CD	Ю			
14	SD_CK	0			
15	SD_D3	Ю	SD/SDHC interface,The SD_CK connects a 22pF capacitor to GND		
16	SD_D2	10	near the SD card interface.		
17	SD_D1	Ю			
18	SD_D0	Ю			
19	PWM0	0	2 16-bit PWM output. The external 10K resistor should be pulled down to the ground to ensure that power-on is low level.		
20	PWM1	0	The OS core can be controlled in real time via UART3.		

21	P3.3	Ю	If using RX8130 or SD2058 I2C RTC to connect to both IOs, SCL should be connected to P3.2,and SDA connected to P3.3 in parallel with 10K resistor pull-up to 3.3V.	
22	P3.2	Ю		
23	P3.1/EX1	Ю	It can be used as an external interrupt 1 input at the same time, and supports both low voltage level or trailing edge interrupt modes.	
24	P3.0/EX0	Ю	It can be used as an external interrupt 0 input at the same time, and supports both low voltage level or trailing edge interrupt modes.	
25	P2.7	Ю	IO interface	
26	P2.6	Ю	IO interface	
27	P2.5	Ю	IO interface	
28	P2.4	Ю	IO interface	
29	P2.3	Ю	IO interface	
30	P2.2	Ю	IO interface	
31	P2.1	Ю	IO interface	
32	P2.0	Ю	IO interface	
33	P1.7	Ю	IO interface	
34	P1.6	Ю	IO interface	
35	P1.5	Ю	IO interface	
36	P1.4	Ю	IO interface	
37	P1.3	Ю	IO interface	
38	P1.2	Ю	IO interface	
39	P1.1	Ю	IO interface	
40	P1.0	Ю	IO interface	
41	UART4_TXD	0	LIADT4	
42	UART4_RXD	ı	- UART4	
43	UART5_TXD	0	- UART5	
44	UART5_RXD	I	UAINTO	
45	P0.0	Ю	IO interface	
46	P0.1	Ю	IO interface	
47	CAN_TX	0	CAN interface,(External CAN chip drive is required.See 6 - (6) for circuit	
48	CAN_RX	I	reference)	
49	UART2_TXD	0		
50	UART2_RXD	I	UART2(UART0 serial port of OS core)	

2 Specification Parameters

2.1 Product Parameters

Main Chip	T5L0		
User Interface	50Pin_0.5mm FPC		
FLASH	8M Bytes		
UI Version	TA / DGUS II		
Power Supply	HDL662S adapter board power supply.		
Dimensions	4.3 inch		
Resolution	480*800		
Active Area (AA)	56.16mm (W)×93.60mm (H)		
Viewing Area (VA)	56.56mm (W)×94.00mm (H)		
Viewing Angle	Wide viewing angle (85°/85°/85°/85° typical), high contrast, and good color reproduction.		
Backlight Service Life	>10000 hours		
Brightness	100nit		
Brightness Control	100-level brightness adjustment (Flickering may occur at 1%-30% of max brightness; not recommended for use in this range)		
Note: Use dynamic screen saver to	prevent afterimages from prolonged fixed page display.		
ТР Туре	Capacitive Touch Panel		
Structure	G+G structure with mirror glass surface and hardness≷6H.		
Light Transmittance	35%~45%		

2.2 Interface Parameters

Item	Conditions	Min	Тур	Max	Unit
Baud Rate	User Set(Configure the CFG file)	3150	115200	3225600	bps
Output	Output 1	3.0	3.3	-	V
Voltage(TXD)	Output 0	-	0	0.3	V
Input	Input 1	-	3.3	-	V
Voltage(RXD)	Input 0	0	-	0.5	V
Interface	UART2: TTL; UART4: TTL; (Only available after OS configuration) UART5: TTL; (Only available after OS configuration)				
Data Format	UART2: N81; UART4: N81/E81/O81/N82; 4 modes (OS configuration) UART5: N81/E81/O81/N82; 4 modes (OS configuration)				

2.3 Electrical Specifications

Rated Power	<5W		
Operating Voltage	3.6-5.5V, typical value of 5V.		
Operating Current	270mA VCC=5V, max backlight.		
Recommended power supply: 5V 1A DC.			

2.4 Operating Environment

Operating Temperature	-10℃ to 60℃
Storage Temperature	-20℃ to 70℃
Operating Humidity	10%-90%RH, typical value of 60% RH.

3 Reliability Test

3.1 Electrostatic Discharge Test

Test temperature: 25°C. Test humidity: 50%RH.

Test process: Place the product on the test bench fixture (approximately 15cm in height), and perform contact and air discharge tests on the smart LCM. Observe if any freezing, black or white screen, flickering, or rebooting occurs during the test.

Test conclusion: The product's ESD performance meets GB/T 17626.2 Class B standards.

Discharge Type	Discharge Value	Result
Air discharge	±8KV	Normal operation

3.2 High and Low Temperature Test

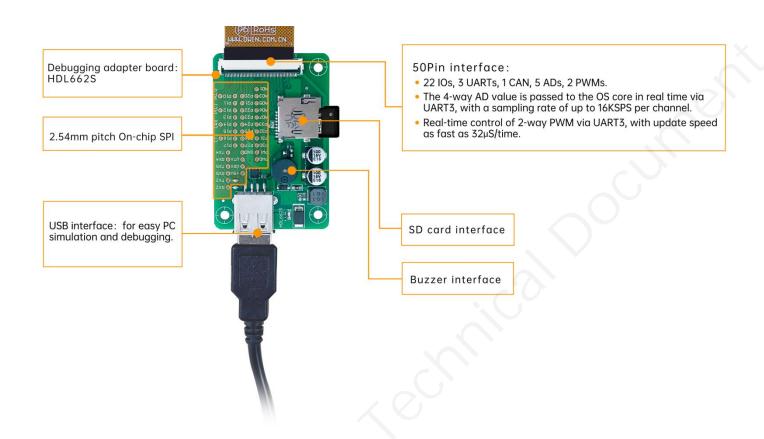
Test temperature:-20 to 70 °C.

Test process: the product will be placed obliquely in the high and low temperature test chamber for 12h for 20 on and off cycles. Then it will be check at room temperature after power on for the appearance and function, CTP offset situation, jumping point, page random switching and failure.

Temperature	Result
High temperature (70°C)	Normal operation
Low temperature (-20°C)	Normal operation

4 Debug

It is recommended for new users of DWIN smart LCMs to purchase official accessories. For more details, please refer to customer service center.



Operation steps: open serial assistant - custom function command - set command - send.

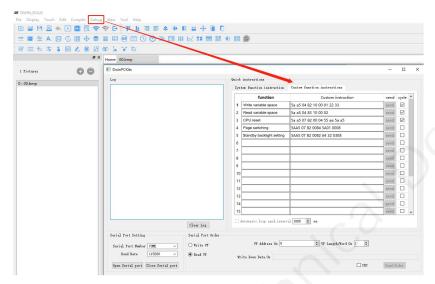
For example:

(1) Page switching

Tx: 5AA5 07 82 0084 5A01 0008

(2) Standby backlight setting

Tx: 5AA5 07 82 0082 64 32 03E8



DGUS operation

5 T5L0 ASIC

T5L0 ASIC is a low-power, cost-effective, GUI and application highly integrated single-chip dual-core ASIC designed by DWIN Technology for small-size LCD and mass produced in 2020.

- (1) Mature and stable 8051 core which is the most widely used with the maximum operating frequency of T5L is up to 250MHz, 1T(single instruction cycle)high speed operation.
- (2) Separate GUI CPU core running DGUS II System:
- High-speed display memory, 2.4GB/S bandwidth. 18-bit color display resolution support up to 1024*768
 (TA mode), 854*480 (DGUS mode).
- 2D hardware acceleration and the UI with animation and icons as its main feature is extremely cool and smooth.
- Images and icons stored in JPEG format. Adopt Low-cost 16Mbytes SPI Flash.
- High quality ratio and sound restoration and playback.
- 128Kbytes variable storage space for exchanging data with OS CPU Core and memory.
- 2 10-bit 800KHz DC/DC controllers simplify LED backlight, analog power design and save cost and space.
- Support DGUS development and simulation on PC. Support backend remote upgrade.
- (3) Separate CPU (OS CPU) core runs user 8051 code or DWIN OS system and user CPU is omitted in practical application:
- Standard 8051 core and instruction set, 64Kbytes code space, 32Kbytes on-chip RAM.
- 64-bit integer mathematical operation unit (MDU), including 64-bit MAC and 64-bit divider.
- Built-in software WDT, 3 16-bit Timers, 12 interrupt signals support up to four levels of interrupt nesting.
- Support IAP online simulation and debugging with unlimited breakpoints.
- Upgrade code online through DGUS system.
- (4) 1Mbytes on-chip Flash with DWIN patent encryption technology ensure code and data security.
- (5) Operating temperature ranges from -40 $^{\circ}$ C to +85 $^{\circ}$ C(IC operating temperature customizable from -55 $^{\circ}$ C to 105 $^{\circ}$ C).
- (6) Low power consumption and strong anti-interference ability. It can work stably on double-sided PCB and passes EMC/EMI test easily.

6 COF Screen Secondary Development

Standard 8051 core, easy to develop in C language and assembly language.

(1) 22 IOs:

To use output function of IO, you need to open the output control, output strength and peripheral multiplexing power-on initialization configuration. Subsequent use of IO is consistent with the standard 8051 as follows.

```
#include "sys.h"
sbit LED1 = P1^0;
sbit KEY1 = P1^1;
//Pin initialization
void io_init()
         PORTDRV = 0x01;//Driving current is 8mA
         P1MDOUT |= 0x01;//Set P1.0 as output to drive LED1 light
         P1MDOUT &= 0xFD;//Set P1.1 as input to read the voltage level change of the pin
void main(void)
         u16 cnt 1ms;
         u16 key1_sta;//Store the voltage level state of the KEY1 pin
         sys_init();//System initialization
         io_init();//Pin initialization
         cnt 1ms = 0;
         key1_sta = KEY1;
         while(1)
         {
                  cnt 1ms++;
                  sys_delay_ms(1);// Delay sub-function, LED1 blinks every 500ms.
                  if(cnt 1ms==500)
                          LED1 = !LED1;
                          cnt 1ms = 0;
                 //If the voltage level of the pin has changed, it will be updated in the interface
                 if(key1_sta!=KEY1)
                           key1_sta = KEY1;
                          sys_write_vp(0x1000,(u8*)&key1_sta,1);
                 }
```

(2) 3 UARTs:

High-speed serial port, supporting up to 3225600bps, as follows.

(3) 1 CAN:

Only the special function registers of the CAN need to be configured as follows.

```
void CanInit()
    POMDOUT = 0x04;
                       //P0.2(CAN_TX) is configured as output
    P0 = 0xFF:
                     //Output high voltage level
    ADR H = 0xFF;
                       //Configuring DGUS variable memory addresses
    ADR_M = 0x00;
    ADR_L = 0x60;
    ADR INC = 1;
                       //Configure address increments
    RAMMODE = 0x8F;
                         //Write mode
                        //Waiting for confirmation, Among answers of Hardware to 8051 occupied variable memory request,
    while(!APP ACK);
    1=OK and 0=BUSY, which need to continue to wait.
    DATA3 = 0x1A;
                        //Variable memory address 0xFF:0060 assignment
    DATA2 = 0x17
    DATA1 = 0x0F;
    DATA0 = 0;
    APP_EN = 1;
    while(APP_EN);
                        //Wait for the data operation to be completed, and reset after the operation is completed
    DATA3 = 0;
                      //Acceptance register 0xFF:0061 assignment reset
    DATA2 = 0;
    DATA1 = 0;
    DATA0 = 0;
    APP EN = 1;
    while(APP_EN);
                         //Wait for the data operation to be completed, and reset after the operation is completed
    DATA3 = 0xFF;
                         //Acceptance Mask Register 0xFF:0062 all set to 1, and no acceptance of reception
    DATA2 = 0xFF;
    DATA1 = 0xFF;
    DATA0 = 0xFF:
    APP EN = 1;
    while(APP_EN);
                         //Wait for the data operation to be completed, and reset after the operation is completed
    RAMMODE = 0;
                         //Terminate access to DGUS variable memory
    CAN_CR = 0xA0;
                         //Open CAN and configure FF0060-FF0062
    while(CAN_CR&0x20); // Execute the configuration of FF0060-FF0062
    ECAN = 1;
                      //Open the CAN interrupt
    EA = 1;
                     //Open the total interrupt
```

(4) 5 A/Ds: 12-bit, supports sampling to 16-bit

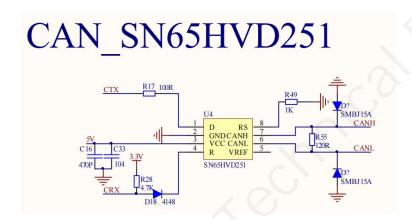
Only the special function registers of the A/Ds need to be configured as follows.

(5) 2 PWMs: 16-bit high accuracy, adjustable resolution.

Only need to configure the frequency and duty cycle of PWM as follows.

```
void Pwm_0()
{
    u8 i=0;
    u8 temp[6]={0xAA,0x20,0x42,0x56,0x78,0};//Set the pwm_0 duty cycle to 100%
    Write_Dgus(0x87,0x2042);//Configure the frequency100khz
    Write_Dgus(0x86,0x5A01);//
    for(i=0;i<5;i++) //Checksum
        temp[5]+=temp[i];
    for(i=0;i<6;i++)//Configure the duty cycle
        OneSendData3(temp[i]);
}</pre>
```

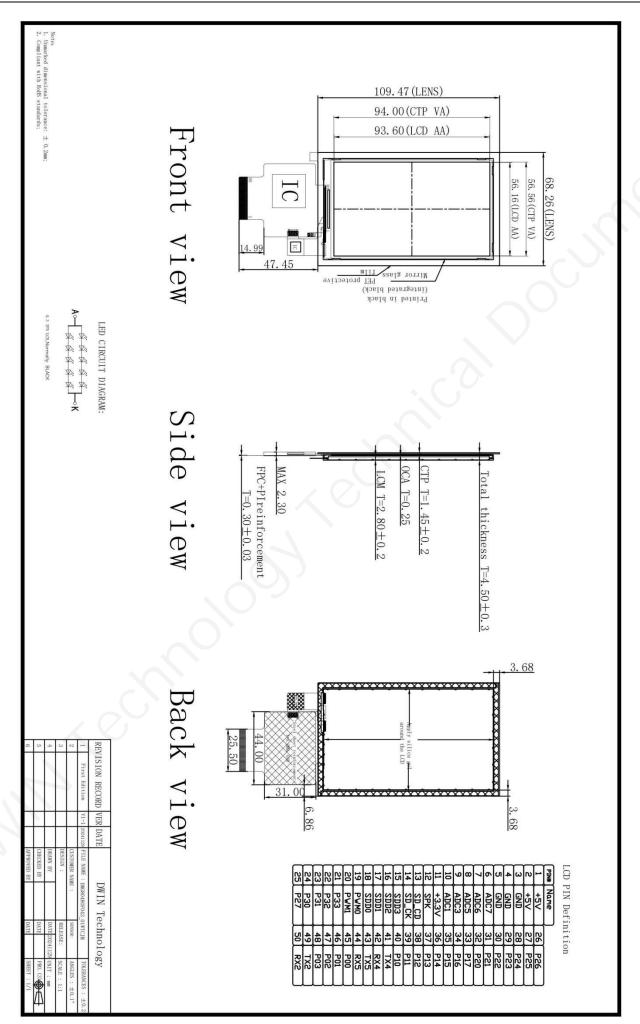
(6) CAN circuit design parameters



7 Packing & dimensions

Dimension					
Dimension	68.26(W)×109.47 (H)×4.50(T) mm	68.26(W)×109.47 (H)×4.50(T) mm			
Net Weight	75g	75g			
Packing Capacity					
Model	Size	Layer	Quantity/Layer	Quantity(Pcs)	
Carton1:	220mm(L)×160mm(W)×47mm(H)	1	4	4	
Carton2:	250mm(L)×200mm(W)×80mm(H)	1	8	8	
Carton3:	320mm(L)×270mm(W)×80mm(H)	1	16	16	
Carton4:	375mm(L)×275mm(W)×200mm(H)	-	-	102	





8 Revision records

Rev Revise Date		Content	Editor
00	2024-12-12	Preliminary version	Xu Ying

Please contact us if you have any questions about the use of this document or our products, or if you would like to know the latest information about our products:

• Customer service Tel: +86 400 018 9008

• Customer service email: dwinhmi@dwin.com.cn

DWIN Developer Forum: https://forums.dwin-global.com/

Thank you all for continuous support of DWIN, and your approval is the driving force of our progress!

Important Disclaimer

DWIN reserves the right to make any changes to product designs without prior notice.

Customers should ensure strictly adhering to all the relevant standards and requirements during the product application process, including but not limited to functional safety, information security, and regulatory provisions.

DWIN shall not bear any joint and several liability for any consequences that may arise from customers' adoption of DWIN products. In particular, for risks that may lead to significant property losses, environmental hazards, personal injury, or even death, especially in high-risk application areas such as military applications, flammable and explosive places, and life-saving medical equipment, customers should independently assess the risks and take corresponding preventive and protective measures. DWIN shall not bear any relevant responsibility.